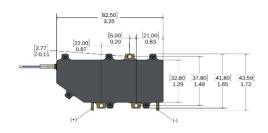
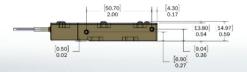


PLD-213-970-CH, 108 W

Multi-mode Fiber-coupled Packaged Diodes









FEATURES

- ▶ 970 nm Center Wavelength
- Wavelength Stabilization and Dichroic Options
- ▶ 108 W Output Power
- ▶ 0.16 NA into 110 µm Fiber Core Diameter
- ▶ High Reliability
- ▶ Robust Compact Package



APPLICATIONS

- ▶ Amplifier Pumping
- ▶ Direct Diode Lasers
- ▶ Laser Pumping
- ▶ Material Processing
- ▶ Graphic Arts / Printing
- ▶ Medical & Dental
- ▶ Illumination
- ▶ Photovoltaics

IPG Photonics' **PLD-213-970-CH** fiber-coupled packaged diodes provide up to 108 W of output power within 0.16 NA. PLD-213 diode features include a 110 µm fiber core diameter and 970 nm center wavelength. Wavelength stabilization and dichroic options are also available.

IPG's best-in-class diode technology offers an ideal combination of power, reliability and form factor. We manufacture to rigorous telecom-grade standards in the world's largest high power diode fab. Each wafer is individually qualified, which sets IPG apart from alternative industrial pump products using short-lived diode bars and bar-stack technologies. PLD-213 packaged diodes are preferred components for fiber amplifier and laser pumping, material processing and direct diode applications.

PLD-213-970-CH, 108 W

Multi-mode Fiber-coupled Packaged Diodes

Optical and Electrical Characteristics*	PLD-213-970-CH
Center Wavelength, nm	968.5
Center Wavelength Tolerance, nm	±5.5
Output Power, W (Typ./Min)	108/100
Wavelength Shift in Current Range 14 - 18 A, nm/A	0.55
Power Shift in Current Range 14 - 18 A, W/A	7.6
Spectral Width, nm	4±2
Threshold Current (I_{TH}), A	1.7
Operating Current (I _{op}), A	14
Forward Voltage, V	<14.2
Recommended Case Temperature, °C	25

^{*} Typical performance data measured at 14A, 25°C

Fiber Characteristics	
Fiber Core Diameter, µm	110
Fiber Cladding Diameter, μm	125
Fiber Buffer Diameter, μm	230
Typ./Max Beam Numerical Aperture (90% power)	0.16/0.18
Fiber Length, m	1.9
Minimum Fiber Bend Radius, mm	30

Maximum Ratings	
Operating Current (I _{OP}), A	18
Reverse Voltage, V	2.5
Case Temperature, °C	5 - 70
Storage Temperature, °C	-20 to 60
Lead Soldering Temperature (10 s max) °C	300
Relative Humidity, %	85



+1 (508) 373-1100;

IPGPhotonics.com/contact

www.ipgphotonics.com

MAX. AVERAGE OUTPUT POWER: <200 W WAVELENGTH RANGE: 900-1000 nm DANGER - INVISIBLE LASER RADIATION AVOID EYE OR SKIN EXPOSURE TO DIRECT OR SCATTERED RADIATION CLASS 4 LASER PRODUCT